

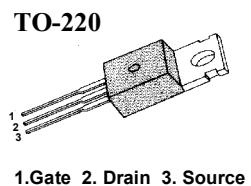
## Advanced Power MOSFET

**IRFZ44A**

### FEATURES

- Avalanche Rugged Technology
- Rugged Gate Oxide Technology
- Lower Input Capacitance
- Improved Gate Charge
- Extended Safe Operating Area
- 175°C Operating Temperature
- Lower Leakage Current : 10 µA (Max.) @  $V_{DS} = 60V$
- Lower  $R_{DS(ON)}$  : 0.020 Ω (Typ.)

$BV_{DSS} = 60 V$   
 $R_{DS(on)} = 0.024 \Omega$   
 $I_D = 50 A$



### Absolute Maximum Ratings

Symbol	Characteristic	Value	Units
$V_{DSS}$	Drain-to-Source Voltage	60	V
$I_D$	Continuous Drain Current ( $T_C=25^\circ C$ )	50	A
	Continuous Drain Current ( $T_C=100^\circ C$ )	35.4	
$I_{DM}$	Drain Current-Pulsed	200	A
$V_{GS}$	Gate-to-Source Voltage	$\pm 20$	V
$E_{AS}$	Single Pulsed Avalanche Energy	857	mJ
$I_{AR}$	Avalanche Current	50	A
$E_{AR}$	Repetitive Avalanche Energy	12.6	mJ
$dv/dt$	Peak Diode Recovery $dv/dt$	5.5	V/ns
$P_D$	Total Power Dissipation ( $T_C=25^\circ C$ )	126	W
	Linear Derating Factor	0.84	W/ $^\circ C$
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	- 55 to +175	$^\circ C$
	Maximum Lead Temp. for Soldering Purposes, 1/8 " from case for 5-seconds	300	

### Thermal Resistance

Symbol	Characteristic	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	--	1.19	$^\circ C / W$
$R_{\theta CS}$	Case-to-Sink	0.5	--	
$R_{\theta JA}$	Junction-to-Ambient	--	62.5	

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## Electrical Characteristics ( $T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	60	--	--	V	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$
$\Delta \text{BV}/\Delta T_J$	Breakdown Voltage Temp. Coeff.	--	0.063	--	$\text{V}/^\circ\text{C}$	$\text{I}_D=250\mu\text{A}$ See Fig 7
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	2.0	--	4.0	V	$\text{V}_{\text{DS}}=5\text{V}, \text{I}_D=250\mu\text{A}$
$\text{I}_{\text{GSS}}$	Gate-Source Leakage , Forward	--	--	100	nA	$\text{V}_{\text{GS}}=20\text{V}$
	Gate-Source Leakage , Reverse	--	--	-100		$\text{V}_{\text{GS}}=-20\text{V}$
$\text{I}_{\text{DSS}}$	Drain-to-Source Leakage Current	--	--	10	$\mu\text{A}$	$\text{V}_{\text{DS}}=60\text{V}$
		--	--	100		$\text{V}_{\text{DS}}=48\text{V}, \text{T}_C=150^\circ\text{C}$
$\text{R}_{\text{DS(on)}}$	Static Drain-Source On-State Resistance	--	--	0.024	$\Omega$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=25\text{A}$ ④
$\text{g}_{\text{fs}}$	Forward Transconductance	--	32.6	--	$\text{S}$	$\text{V}_{\text{DS}}=30\text{V}, \text{I}_D=25\text{A}$ ④
$\text{C}_{\text{iss}}$	Input Capacitance	--	1770	2300	pF	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=25\text{V}, f=1\text{MHz}$ See Fig 5
$\text{C}_{\text{oss}}$	Output Capacitance	--	590	680		
$\text{C}_{\text{rss}}$	Reverse Transfer Capacitance	--	220	255		
$t_{\text{d(on)}}$	Turn-On Delay Time	--	20	40	ns	$\text{V}_{\text{DD}}=30\text{V}, \text{I}_D=50\text{A}, \text{R}_G=9.1\Omega$ See Fig 13 ④⑤
$t_r$	Rise Time	--	16	40		
$t_{\text{d(off)}}$	Turn-Off Delay Time	--	68	140		
$t_f$	Fall Time	--	70	140		
$\text{Q}_g$	Total Gate Charge	--	64	83	nC	$\text{V}_{\text{DS}}=48\text{V}, \text{V}_{\text{GS}}=10\text{V}, \text{I}_D=50\text{A}$ See Fig 6 & Fig 12 ④⑤
$\text{Q}_{\text{gs}}$	Gate-Source Charge	--	12.3	--		
$\text{Q}_{\text{gd}}$	Gate-Drain( "Miller" ) Charge	--	23.6	--		

## Source-Drain Diode Ratings and Characteristics

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
$\text{I}_s$	Continuous Source Current	--	--	50	A	Integral reverse pn-diode in the MOSFET
$\text{I}_{\text{SM}}$	Pulsed-Source Current ①	--	--	200		
$\text{V}_{\text{SD}}$	Diode Forward Voltage ④	--	--	1.8	V	$\text{T}_J=25^\circ\text{C}, \text{I}_s=50\text{A}, \text{V}_{\text{GS}}=0\text{V}$
$\text{t}_{\text{rr}}$	Reverse Recovery Time	--	85	--	ns	$\text{T}_J=25^\circ\text{C}, \text{I}_F=50\text{A}$ $d\text{I}/dt=100\text{A}/\mu\text{s}$ ④
$\text{Q}_{\text{rr}}$	Reverse Recovery Charge	--	0.24	--	$\mu\text{C}$	

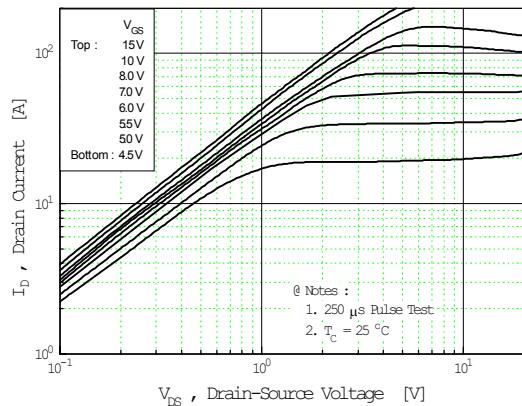
### Notes :

- ① Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- ②  $L=0.4\text{mH}, \text{I}_{\text{AS}}=50\text{A}, \text{V}_{\text{DD}}=25\text{V}, \text{R}_G=27\Omega, \text{Starting } \text{T}_J=25^\circ\text{C}$
- ③  $\text{I}_{\text{SD}}\leq 50\text{A}, \text{di}/\text{dt}\leq 350\text{A}/\mu\text{s}, \text{V}_{\text{DD}}\leq \text{BV}_{\text{DSS}}, \text{Starting } \text{T}_J=25^\circ\text{C}$
- ④ Pulse Test : Pulse Width =  $250\mu\text{s}$ , Duty Cycle  $\leq 2\%$
- ⑤ Essentially Independent of Operating Temperature

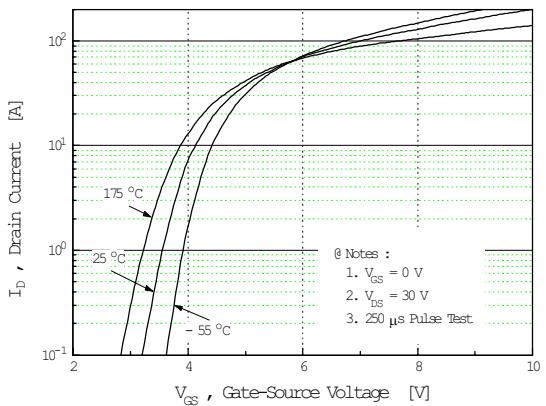
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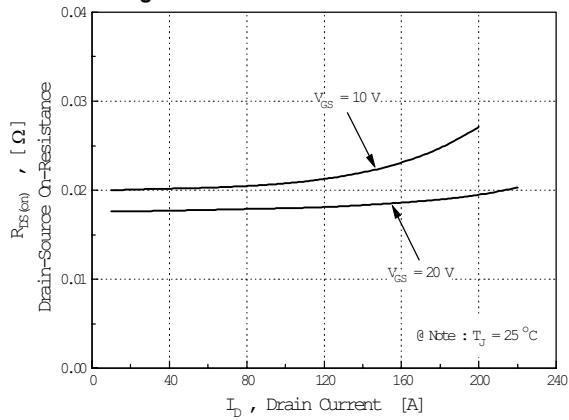
**Fig 1. Output Characteristics**



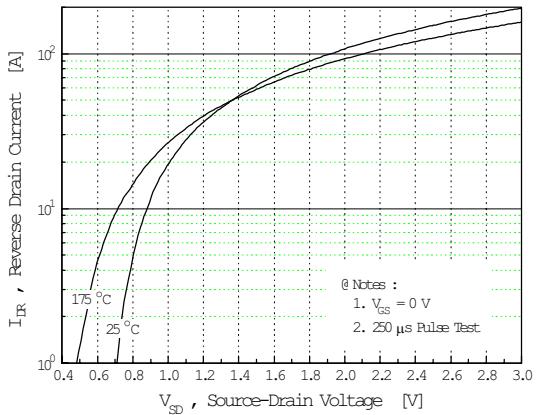
**Fig 2. Transfer Characteristics**



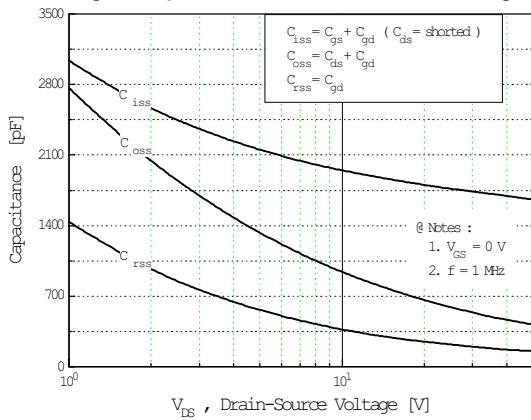
**Fig 3. On-Resistance vs. Drain Current**



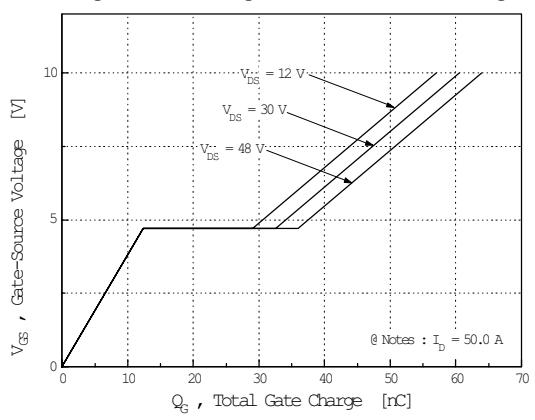
**Fig 4. Source-Drain Diode Forward Voltage**



**Fig 5. Capacitance vs. Drain-Source Voltage**



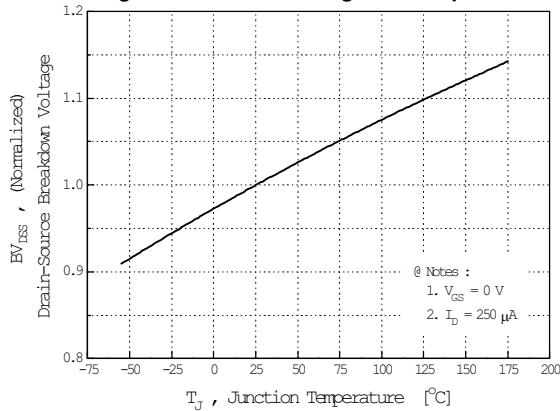
**Fig 6. Gate Charge vs. Gate-Source Voltage**



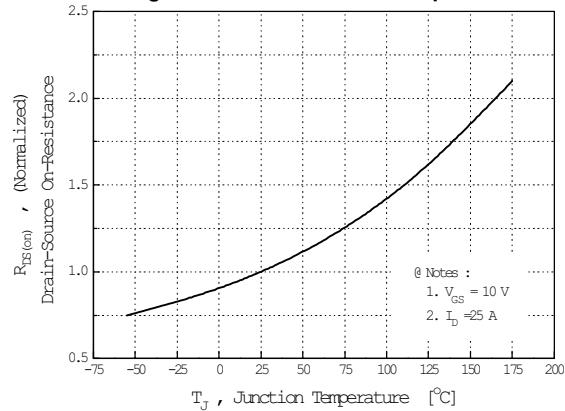
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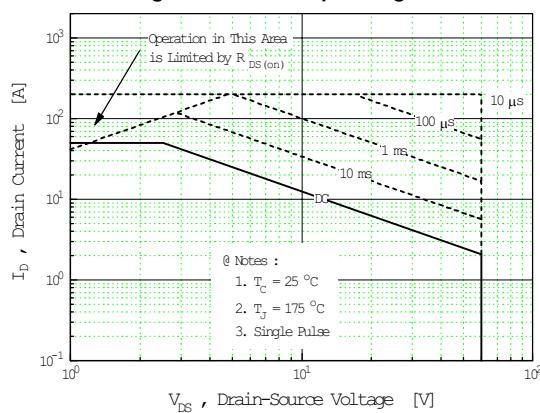
**Fig 7. Breakdown Voltage vs. Temperature**



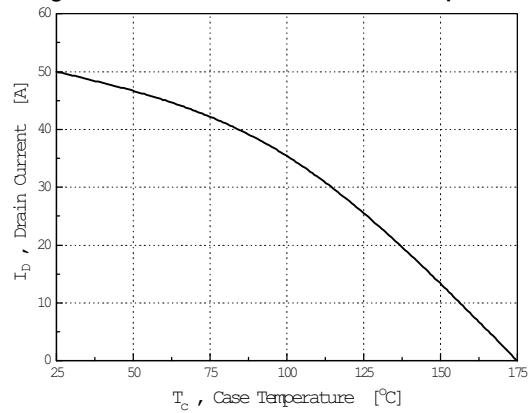
**Fig 8. On-Resistance vs. Temperature**



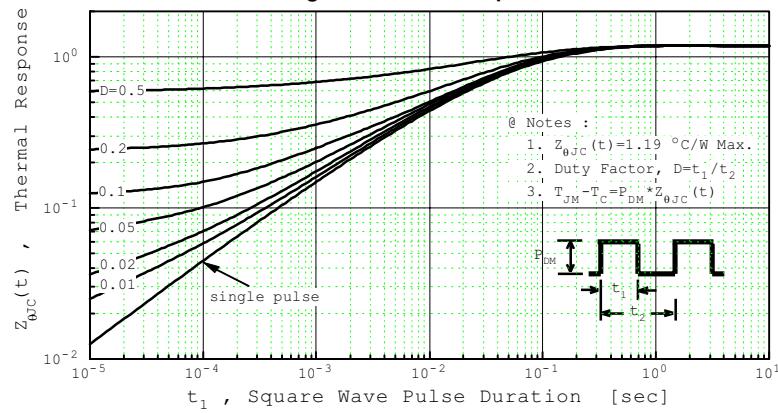
**Fig 9. Max. Safe Operating Area**



**Fig 10. Max. Drain Current vs. Case Temperature**



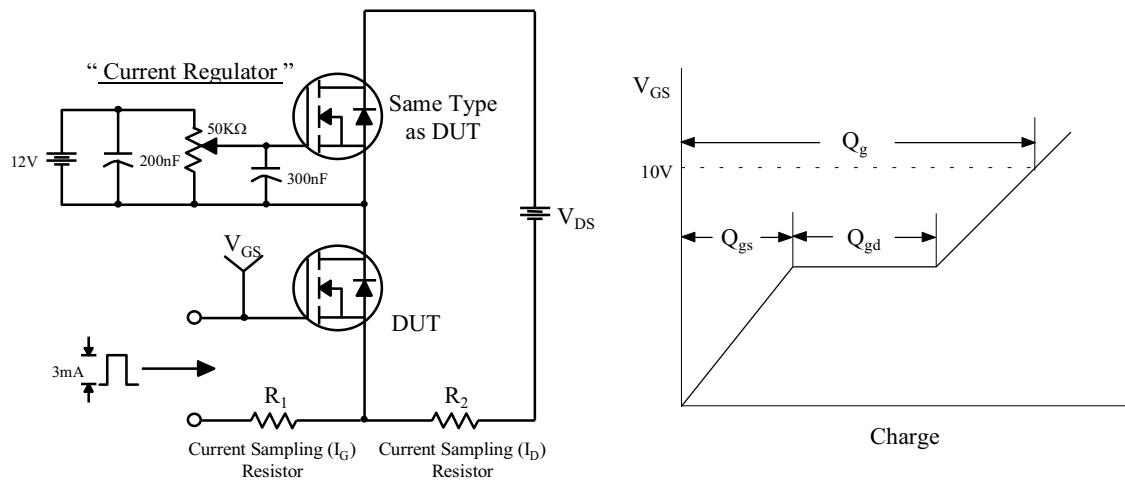
**Fig 11. Thermal Response**



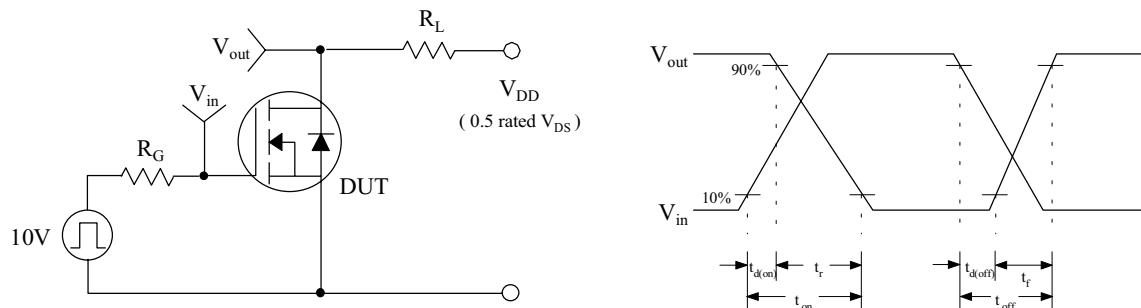
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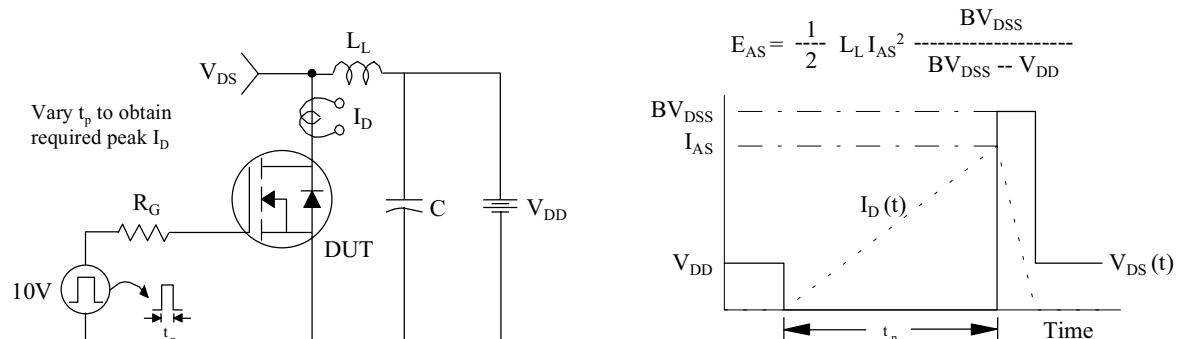
**Fig 12. Gate Charge Test Circuit & Waveform**



**Fig 13. Resistive Switching Test Circuit & Waveforms**



**Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms**



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Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

